

ABSTRACT

A stencil having a porous resin layer provided on one side of a thermoplastic resin film, and a porous fiber layer bonded by an adhesive to the surface of the porous resin layer, wherein the bonding between the thermoplastic resin film and the porous fiber layer is performed by using the amount of the adhesive in a determined amount ranges from 0.05 g/m² to 15.0 g/m² by dry basis, so that an interruption of the passing-through the layers by printing ink is eliminated, and a desired degree of the bonding strength to inhibit an undesirable expansion or breaking-down of the printing stencil is ensured.